

Antenna Switch Control

The MDC5101 inputs TxE and RxE Logic Signals with an accessory input termination option and, allows positive and negative control voltages in accordance with the enclosed truth table. This device is primarily intended to control GaAs RF switches. It is also designed to interface with most HCMOS MCUs such as the ON Semiconductor MC68338.

The MDC5101 is intended to replace a circuit of up to 18 discrete components and is available in a Micro–8 package. This device, in combination with a compatible RF switch, can be used to achieve duplex isolation in any Time Division Duplex Radio like GSM and DCS1800 with staggered Transmit Receive Time Slots. It can also be used to control an RF switch in dual band radio applications.

This integrated solution in a Micro-8 package compared with a discrete solution will add a great value in performance with less board space consumption.

Features

- Miniature Micro-8 Surface Mount Package Saves Board Space
- Logic Level Control
- Designed to Interface with Microcontrollers

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Positive Power Supply Voltage (1)	V _{CC}	15	Vdc
Negative Power Supply Voltage (2)	V _{EE}	-12	Vdc
Differential Power Supply Voltage	V _{CC} -V _{EE}	15	Vdc
Input Voltage ⁽³⁾	V _{in}	V _{CC}	Vdc
Output Current (4)	l ₁ , l ₂	5.0	mAdc
Operating Temperature Range	T _A	-40 to +85	°C
Storage Temperature Range	T _{stg}	-55 to +150	°C
Junction Temperature	TJ	150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Total Power Dissipation Derate above 25°C	P _D	510 4.0	mW mW/°C
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	245	°C/W

Note 1: Pin 1 Referenced to Ground Note 2: Pin 6 Referenced to Ground Note 3: Pin 3, 4 Referenced to Ground Note 4: Pin 5, 7 Referenced to Ground

DEVICE MARKING

5101

ORDERING INFORMATION

MDC5101R2 13 inch Reel, 4000 units

ESD Rating

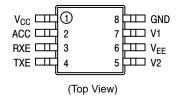
ESD protection on each pin to ±2500 V per MIL-STD6883 method 3015, using human body model of 100 pF, 1500 Ohms and using the machine model to ±200 V at 100 pF and 0 Ohms. Parts must meet electrical requirement after testing.

MDC5101

ANTENNA SWITCH CONTROLLER



PLASTIC PACKAGE CASE 846A-02 (Micro-8)



ELECTRICAL CHARACTERISTICS (V_{CC} = 2.75 V, V_{FF} = -5.0 V, T_A = T_{low} to T_{high} unless otherwise noted)

Characteristic					Symbol	Min	Тур	Max	Unit
OC PARAM	METERS								•
Positive Power Supply Current V1, V2, ACC 10 k Ω to GND, RxE = V _{IH} , TxE = V _{IL}					I _{CC}	_	_	1.0	mA
Negative Power Supply Current					I _{EE}	_	-50	_	μΑ
V1, V2, ACC Open, RxE = V _{IL} , TxE = V _{IH} Negative Power Supply Current V1, V2, ACC 10 kg CND, RyE = V, TyE = V				I _{EE}	-1.5		_	mA	
V1, V2, ACC 10 k Ω to GND, RxE = V _{IL} , TxE = V _{IH} High Level Output Voltage $I_1 = I_2 = 250 \ \mu\text{A, ACC Open}$ RxE = V _{IL} , TxE = V _{IH} RxE = V _{IH} , TxE = V _{IL}				V _{OH(V1)} V _{OH(V2)}	V _{IH} -0.25 V _{IH} -0.25			Vdc	
RxE = V	$_{IL}$, $TxE = V_{IH}$	10 kΩ to GNE)		V _{OH(V2)} V _{OH(V1)}	V _{IH} -0.25 V _{IH} -0.25			
RxE = V_{IH} , TxE = V_{IL} Low Level Output Voltage $I_1 = I_2 = 250 \mu A$, ACC Open RxE = TxE = V_{IL} RxE = V_{IH} , TxE = V_{IL}				V _{OL(V1,V2)} V _{OL(V1)}	-0.5 -0.5	0 0	0.5 0.5	Vdc	
I_1 = I_2 = 250 μA, ACC 10 kΩ to GND RxE = TxE = V_{IL} RxE = V_{IH} , TxE = V_{IL}					V _{OL(V1,V2)} V _{OL(V2)}	-0.5 -0.5	0	0.5 0.5	
Low Level Output Voltage $I_1 = I_2 = 250 \mu A$, $TxE = V_{IH}$, $RxE = V_{IL}$ ACC Open ACC 10 k Ω to GND					V _{OL(V2)} V _{OL(V1)}			-4.5 -4.5	Vdc
AC PARAM	METERS								
ACC Op RxE, Txl	E to V1, V2 en E to V1, V2 kΩ to GND				t _{PLH} — — 1.5 t _{PHL} — — 1.5 t _{PLH} — — 1.5 t _{PHL} — — 5.0 t _{PHL} — — 5.0				μѕ
RUTH TA	RIF				PAL			0.0	ı
	Input Logic		Outpu	ıt Logic					
RxE	TxE	ACC	V2	V1					
0	0	0	0	0					
0	0	1	0	0					
0	1	0	-5.0	2.7					
0	1	1	2.7	-5.0					
1	0	0	2.7	0					
1	0	1	0	2.7					
1	1	0	2.7	2.7		State not allo	wed in softwa	are	
1	1	1	2.7	2.7		State not allo			
		Open, ACC Lo							
Note: ACC	-				V _{IL}				Vdc
	Input Voltage E					_	_	0.4	
Low Level RxE, TxI	E Input Voltage				V _{IH}	2.5	_	0.4	

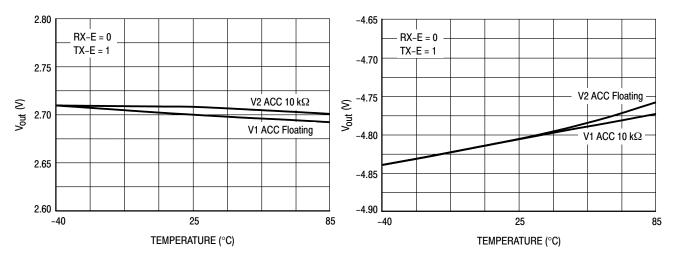


Figure 1. V_{out (high)} versus Temperature

Figure 2. $V_{out (low)}$ versus Temperature

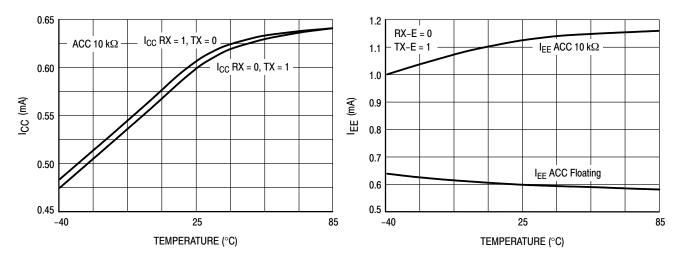


Figure 3. I_{CC} versus Temperature

Figure 4. I_{EE} versus Temperature

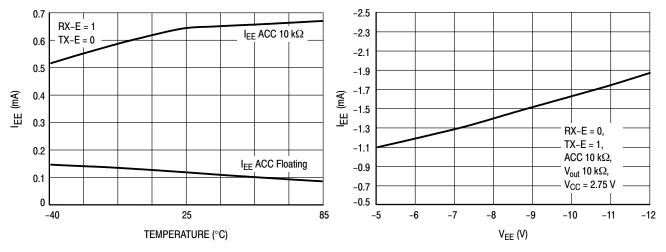


Figure 5. I_{EE} versus Temperature

Figure 6. I_{EE} versus V_{EE}

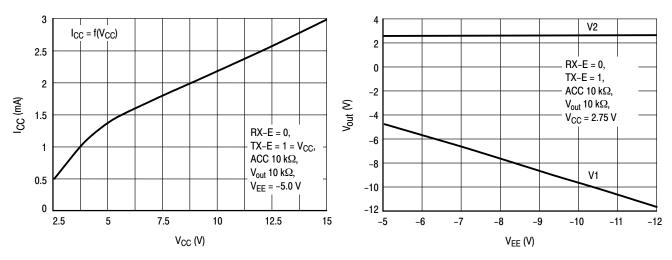


Figure 7. I_{CC} versus V_{CC}

Figure 8. V_{out} versus V_{EE}

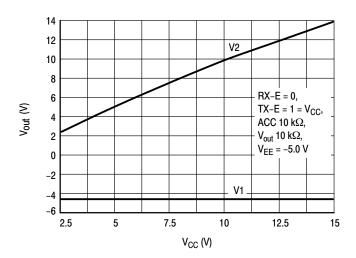


Figure 9. V_{out} versus V_{IH}/V_{CC}

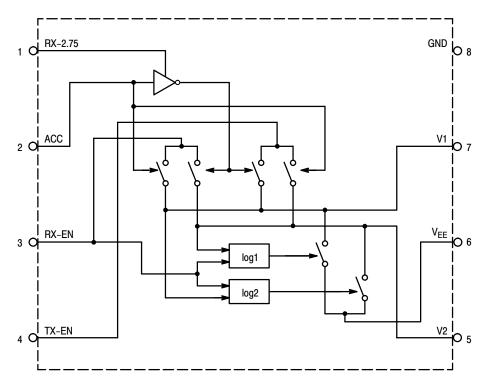


Figure 10. Antenna Switch Controller Block Diagram

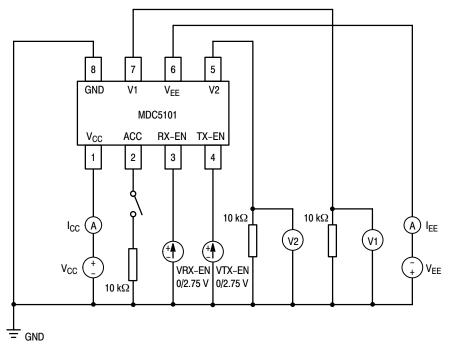


Figure 11. Temperature Measurement Schematic

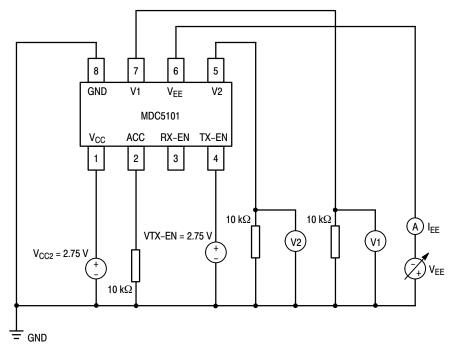


Figure 12. Measurement Schematic V_{out} vs V_{EE} & I_{EE} vs V_{EE}

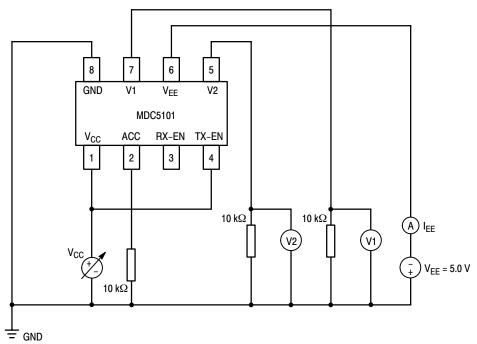
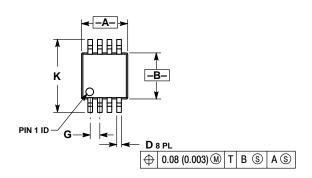
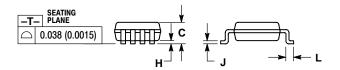


Figure 13. Measurement Schematic V_{out} vs V_{CC}

PACKAGE DIMENSIONS

Micro8 CASE 846A-02 **ISSUE E**





- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: MILLIMETER.

 3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.

 4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	2.90	3.10	0.114	0.122	
В	2.90	3.10	0.114	0.122	
С		1.10		0.043	
D	0.25	0.40	0.010	0.016	
G	0.65 BSC		0.026 BSC		
Н	0.05	0.15	0.002	0.006	
J	0.13	0.23	0.005	0.009	
K	4.75	5.05	0.187	0.199	
L	0.40	0.70	0.016	0.028	

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